

1.02 TYP\_



NO.	WIRE	NUMBERS	LOADED
1		ALL	

NO.	PLATING	
1	15u" GXT	
2	30u" GXT	
3	50u" GXT	
4	15u" Au	
5	30u" Au	
6	50u" Au	

NO.

DIM A  $3.20 \pm 0.50$ 1.50±0.30

00.89 TYP	
\$\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	8.890
ø2.0 - ø3.20 TYP(	

1.27

## RECOMMENDED PC BOARD LAYOUT

11.43

15.44

PCB GENERALLY TOLERANCE: ±0.05

## NOTES:

1. RECOMMENDED P.C.B THICKNESS 1.60 MM EXCEPT -0XX2LF 2 10122517-0XX2LF IS CUSTOMER SPECIAL REQUIREMENT, THERE IS A MYLAR, AND CUSTOMER CHOOSES HIS OWN PCB.

1.270

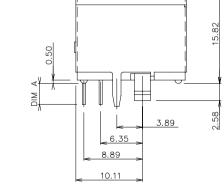
2.01

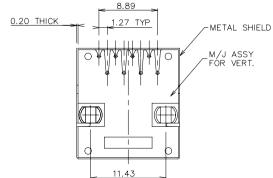
- 3. HOUSING MATERIAL: NYLON UL 94V-0, BLACK.
- 4. CONTACTS: COPPER ALLOY, PLATING SEE P/N.
- 5. METAL SHELL MATERIAL:

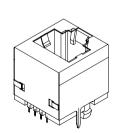
COPPER ALLOY, 0.20mm THICK FINISH: UNDERPLATING WITH 50u" MIN. NICKEL OVERPLATING WITH 80u" MIN PURE BRIGHT TIN

- 6. PACKAGING: GES-14-351, USE TRAY
- 7. PRODUCT SPEC: GS-12-083.
- 7. IF LF P/N THE PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008
- 8. IF LF P/N THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.60mm MINIMUM THICK CIRCUIT BOARD
- 9. IF LF P/N PACKAGING MEETS GS-14-920 SPECIFICATION

Ø3.556  Ø3.65  Ø3.65  Ø3.65
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PDS: Rev :A 3

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